| | Type | Hits | Search Text | DBs | Time Stamp | Comments |
|---|---|---|---|---|---|---|
| 1 | BRS | 9279 | 702/22,23,24,27,28,30-36,40,56,57,60,64,65,81-84,99,104,113-119,124,126,130,132-134,138,183,184,189.ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:07 | |
| 2 | BRS | 5117 | 700/51,80,83,89,100,109,110,121,169,291,19-21,50,108,9.ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 17:06 | |
| 3 | BRS | 5768 | 438/5,10,14,17.ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:08 | |
| 4 | BRS | 2355 | 716/2,4.ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:09 | |
| 5 | BRS | 36 | (utilit$3 or consumption$1 or resource$1) with fabricat$3 with process$3 with tool$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:11 | |

| Type | Hits | Search Text | DBs | Time Stamp | Comments |
|------|------|-------------|-----|------------|----------|
| 6 | BRS | 0 | (comput$3 or accumulat$3 or calculat$3) with total with (utilit$3 or consumption$1 or resource$1) with fabricat$3 with process$3 with tool$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:12 | |
| 7 | BRS | 1 | (comput$3 or accumulat$3 or calculat$3) with total with (utilit$3 or consumption$1 or resource$1) with (duration$1 or interval$1 or period$1) and fabricat$3 with process$3 with tool$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:35 | |
| 8 | BRS | 5 | (comput$3 or accumulat$3 or calculat$3) with (utilit$3 or consumption$1 or resource$1) with (duration$1 or interval$1 or period$1) and fabricat$3 with process$3 with tool$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:13 | |

| Type | Hits | Search Text | DBs | Time Stamp | Comments |
|---|---|---|---|---|---|
| BRS | 5 | (comput$3 or accumulat$3 or calculat$3) with (utilit$3 or consumption$1 or resource$1) with (duration$1 or interval$1 or period$1) and fabricat$3 with process$3 with tool$1 and (semiconductor$1 or wafer$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:15 | |
| BRS | 5 | (comput$3 or accumulat$3 or calculat$3) with (utilit$3 or consumption$1 or resource$1) with (duration$1 or interval$1 or period$1) and fabricat$3 with process$3 with tool$1 and (semiconductor$1 or wafer$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) and (input$1 or output$1) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:18 | |

| Type | Hits | Search Text | DBs | Time Stamp | Comments |
|------|------|-------------|-----|------------|----------|
| 11 | BRS | 2 | "20020055801" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:19 | |
| 12 | BRS | 1 | total with (comput$3 or accumulat$3 or calculat$3)with (utilit$3 or consumption$1 or resource$1) with (duration$1 or interval$1 or period$1) and (semiconductor$1 or wafer$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) with process$3 with tool$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:36 | |
| 13 | BRS | 15 | (comput$3 or accumulat$3 or calculat$3)with (utilit$3 or consumption$1 or resource$1) with (duration$1 or interval$1 or period$1) and (semiconductor$1 or wafer$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) with process$3 with tool$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:43 | |

| Type | Hits | Search Text | DBs | Time Stamp | Comments |
|---|---|---|---|---|---|
| 14 | BRS | 16 | input$1 with output$1 with (semiconductor$1 or wafer$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) with recipe$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:43 | |
| 15 | BRS | 0 | input$1 with output$1 with (semiconductor$1 or wafer$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) with recipe$1 and resource$1 with consumption$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:44 | |
| 16 | BRS | 2 | input$1 with output$1 with (semiconductor$1 or wafer$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) with recipe$1 and resource$1 with consumption$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:44 | |
| 17 | BRS | 2 | input$1 with output$1 with (semiconductor$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) with recipe$1 and consumption$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:44 | |

| Type | Hits | Search Text | DBs | Time Stamp | Comments |
|---|---|---|---|---|---|
| 18 BRS | 2 | input$1 with output$1 with (semiconductor$1 or wafer$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) with recipe$1 and consumpt$3 with (time$1 or period$1 or duration$1 or interval$1) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:45 | |
| 19 BRS | 7 | input$1 with output$1 with (semiconductor$1 or wafer$1 or integrated adj circuit$1 or IC$1 or chip$1 or die$1) with recipe$1 and consum$7 with (time$1 or period$1 or duration$1 or interval$1) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:45 | |
| 20 IS&R | 6 | (("5153837") or ("5586039") or ("5586059") or ("5757673") or ("5801961") or ("6228563")).PN. | USPAT | 2005/01/20 16:58 | |
| 21 BRS | 6 | "2001003.9462" "2002005.5801" "2002007.2162" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/01/20 16:56 | |

| Type | Hits | Search Text | DBs | Time Stamp | Comments |
|---|---|---|---|---|---|
| 22 | BRS | 2 | "20020156548" | US-PGPUB;<br>USPAT; EPO;<br>JPO; DERWENT;<br>IBM_TDB | 2005/01/20<br>16:57 | |
| 23 | BRS | 0 | S21 and S22 | US-PGPUB | 2005/01/20<br>16:56 | |
| 24 | BRS | 8 | S21 or S22 | US-PGPUB;<br>USPAT; EPO;<br>JPO; DERWENT;<br>IBM_TDB | 2005/01/20<br>16:57 | |
| 25 | IS&R | 9 | (("5153837") or<br>("5586039") or ("5586059")<br>or ("5757673") or<br>("5801961") or ("6228563")<br>or ("6408220") or<br>("6368975") or<br>("6496200")).PN. | USPAT | 2005/01/20<br>16:58 | |
| 26 | BRS | 5143 | 700/51,80,83,89,100,109,11<br>0,111,121,169,291,19-<br>21,50,108,9.ccls. | US-PGPUB;<br>USPAT; EPO;<br>JPO; DERWENT;<br>IBM_TDB | 2005/01/20<br>17:06 | |